











# JS025F -- MAY 2001 - REVISED JULY 2002

FOR SINGLE- AND TWO-CELL LITHIUM-ION AND LITHIUM-POLYMER

DESCRIPTION

ADVANCED LINEAR CHARGE MANAGEMENT IC

#### FEATURES

- Ideal for Single (4.1 V or 4.2 V) and Dual-Cell (8.2 V or 8.4 V) Li-lon or Li-Pol Packs
- Requires Small Number of External Components
- 0.3 V Dropout Voltage for Minimizing Heat Dissipation
- Better Than ±1% Voltage Regulation Accuracy With Preset Voltages
- AutoComp " Dynamic Compensation of Charge Time Battery Pack's Internal Impedance to Reduce
- Optional Cell-Temperature Monitoring Before and During Charge
- Integrated Voltage and Current Regulation Integrated Cell Conditioning for Reviving With Programmable Charge-Current and Highor Low-Side Current Sensing
- Charge Status Output for Single or Dual Led Dissipation During Initial Stage Of Charge Deeply Discharged Cells and Minimizing Heat
- or Host Processor Interface
- Automatic Battery-Recharge Feature
- Charge Termination by Minimum Current
- Automatic Low-Power Sleep Mode When VCC
- **EVMs Available for Quick Evaluation**
- Packaging: 8-Pin SOIC, 8-Pin TSSOP, 8-Pin

#### S & S bq2057xSN or bq2057xTS SOIC (SN) or TSSOP (TS) PACKAGE (TOP VIEW)

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5 STAI	6 III VSS	7		
A	Š	.,	COMP	



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termination, charge-status indication, and AutoComp charge-rate compensation in a single 8-pin IC. MSOP, charge-management ICs are designed for cost wide range of end applications. battery conditioning, temperature monitoring, charge combine high-accuracy current and voltage regulation. sensitive and compact portable electronics. They Lithium-lon (Li-lon) and Lithium-Polymer (Li-Pol) linear TSSOP, and SOIC package options are offered to fit a BENCHMARQ bq2057 series advanced

bq2057 precharges using a low current to condition the battery. The conditioning charge rate is approximately charges the battery in three phases: conditioning, is within user-defined thresholds. The bq2057 then the bq2057 inhibits charge until the battery temperature temperature using an external thermistor. For safety The voltage is below the low-voltage threshold, V(min), the constant current, and constant voltage. If the battery of the battery without additional components. The the battery. An external sense-resistor sets the current conditioning, the bq2057 applies a constant current to element during the initial stage of the charge. After also minimizes heat dissipation in the external passreaches the charge-regulation voltage constant-current phase continues until the battery The sense-resistor can be on either the high or low side 10% of the regulation current. The conditioning current bq2057 continuously measures

## bq2057xDGK MSOP (DGK) PACKAGE (TOP VIEW)

VSS 🗀	STAT	TS C	VCC ∏	
5	3 6	2 7	10 8	
8	COMP	SNS	BAT	

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bq2057, bq2057C bq2057T, bq2057W

## DESCRIPTION (continued)

termination threshold, I<sub>(TERM)</sub>. The bq2057 automatically restarts the charge if the battery voltage falls below the V<sub>(RCH)</sub> threshold. The bq2057 then begins the constant-voltage phase. The accuracy of the voltage regulation is better than  $\pm 1\%$  over the operating-temperature and supply-voltage ranges. For single and dual cells, the bq2057 is offered in four fixed-voltage versions: 4.1  $\frac{1}{2}$ , 4.2  $\frac{1}{2}$ , 8.2  $\frac{1}{2}$ , and 8.4  $\frac{1}{2}$ . Charge stops when the current tapers to the charge

safe and dynamic compensation for the internal impedance of the battery pack during charge The designer also may use the AutoComp feature to reduce charging time. This proprietary technique allows

#### AVAILABLE OPTIONS

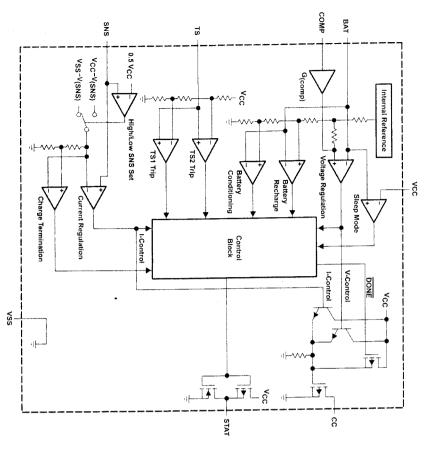
		PACKAGE		
ĪΑ	CHARGE REGULATION VOLTAGE	SOIC (SN)	TSSOP (TS)	MSOP† (DGK)
	4.1 V	Not available	bq2057TS	bq2057DGK
	4.2 V	bq2057CSN	bq2057CTS	bq2057CDGK
-20°C to 70°C	8.2 V	Not available	bq2057TTS	Not available
	847	ba2057WSN	ba2057WTS	THOI DE CONTROL

<sup>&</sup>lt;sup>†</sup> Note the difference in pinout for this package

bq2057, bq2057C bq2057T, bq2057W

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### function block diagram





# bq2057, bq2057C bq2057T, bq2057W

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Terminal Functions

	TERMINAL			
	NO.		ŝ	DESCRIPTION
NAME	SOIC (SN) and TSSOP (TS)	MSOP (DGK)	į	
BAT	2	8	-	Voltage sense input
CC	7	5	0	Charge control output
COMP	8	9	-	Charge-rate compensation input (AutoComp)
SNS	1	7	-	Current sense input
STAT	5	3	0	Charge status output
ST	4	2		Temperature sense input
VCC	3	-1		Supply voltage
VSS	6	4		Ground

#### detailed description

#### current-sense input

Battery current is sensed via the voltage developed on this pin by an external sense resistor. The external resistor can be placed on either the high or low side of the battery. (See schematics for details.)

#### battery-voltage input

# temperature sense input

# Input for an external battery-temperature monitoring circuit. Connecting this input to VCC/2 disables this feature.

charge-status output

Voltage sense-input tied directly to the positive side of the battery.

#### charge-control output

3-state indication of charge in progress, charge complete, and temperature fault or sleep mode.

## charge-rate compensation input

Sets the charge-rate compensation level. The voltage-regulation output may be programmed to vary as a function of the charge current delivered to the battery.

Source-follower output that drives an external pass-transistor (PNP or P-channel MOSFET) for current and voltage regulation.

#### supply voltage input

Power supply input and current reference for high-side sensing configuration.





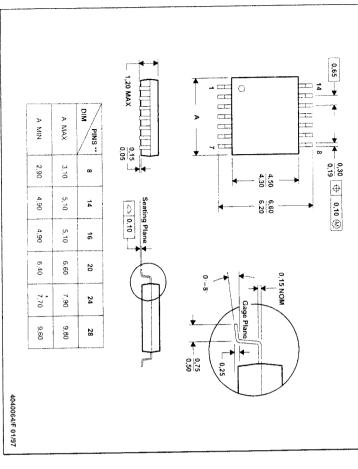
MTSS001C JANUARY 1995 - REVISED FEBRUARY 1999

MECHANICAL DATA

14 PINS SHOWN

PW (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

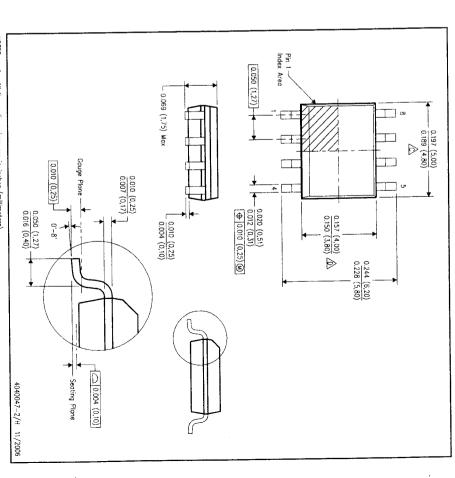
A. All linear dimensions are in millimeters.
 This drawing is subject to change without notice.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or profusion not to exceed 0.15.
 D. Falls within JEDEC MO-153



D (R-PDSO-G8)

# PLASTIC SMALL-OUTLINE PACKAGE

MECHANICAL DATA



NOTES:

All linear dimensions are in inches (millimeters). This drawing is subject to change without notice.

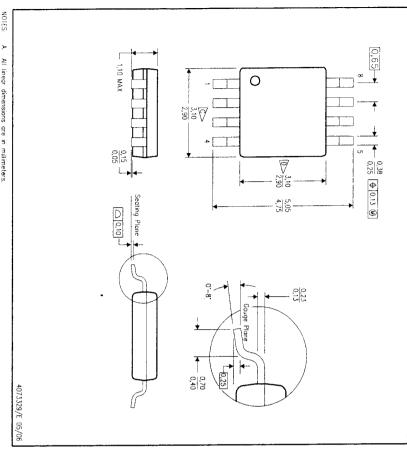
m 🕞 Ø ₽ ≯ Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0.15) per end.
Body width does not include interlead flash. Interlead flash shall not exceed .017 (0.43) per side.
Reference JEDEC MS-012 variation AA.



MECHANICAL DATA

DGK (S-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in milimaters.

  B. This drawing is subject to change without notice.

  C> Body length does not include mold flash, protrusions, or gate burns. Wold flash, protrusions, or gate burns shall not exceed 0.15 per end.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.50 per side
- Falls within JEDEC M0-187 variation AA, except interlead flash.

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Poly Brominated Diphenyl Ethers (PBDE)	1000

(1) Maximum limit does not apply to applications covered by RoHS exemptions

Signature:

Name/Title: Randy Harris, Executive Director, Business Quality

Date:

November 18, 2004

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